

Part Number : 15921430

Product Description: 1.27mm Pitch EBBI 50D

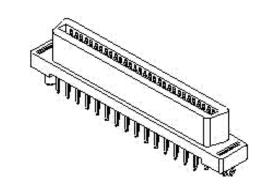
Receptacle, Vertical, 30 Circuits

Series Number: 71660

Status: Active

Product Category: PCB Headers and Receptacles

Engineering Number: A716601330



Documents & Resources

Drawings

015921430 sd.pdf

PK-71660-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

PS-71660-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	⊚ per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	71660
Description	1.27mm Pitch EBBI 50D Receptacle, Vertical, 30 Circuits
Application	Board-to-Board, Signal
Component Type	PCB Receptacle
Product Name	EBBI
UPC	800754397407

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	30V

Physical

Circuits (Loaded)	30
Circuits (maximum)	30

Color - Resin	Black
Durability (mating cycles max)	2000
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	Yes
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	2.000/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.57mm
PC Tail Length	2.79mm
Pitch - Mating Interface	1.27mm
Plating min - Mating	0.762µm
Plating min - Termination	0.254μm
Polarized to PCB	Yes
Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Lead-Free Process Capability	SMC&WAVE
Max-Temp	260

Application Tooling